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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

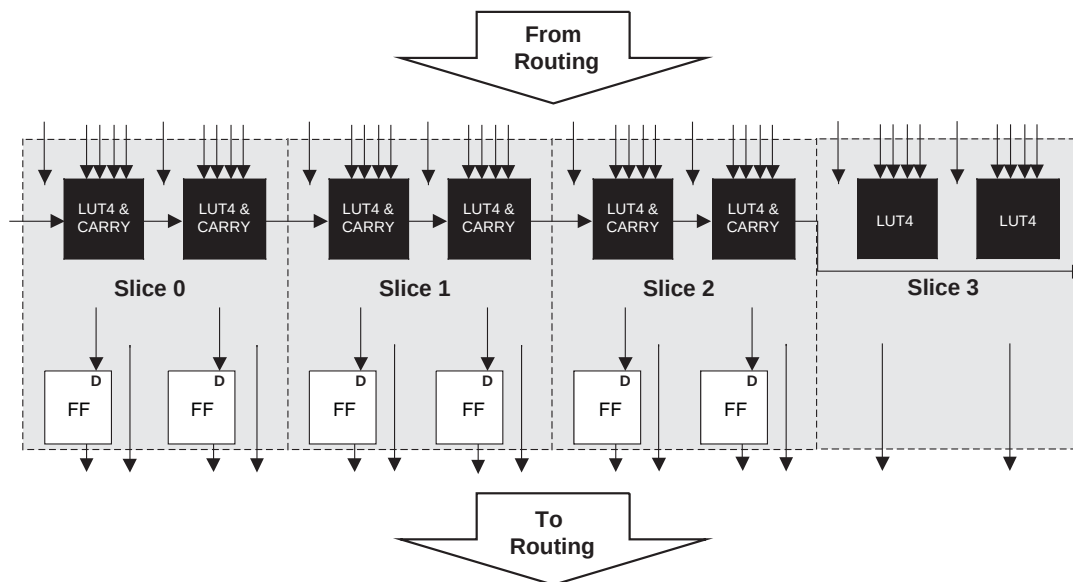
Product Status	Active
Number of LABs/CLBs	750
Number of Logic Elements/Cells	6000
Total RAM Bits	56320
Number of I/O	90
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-6e-5tn144i

PFU Blocks

The core of the LatticeECP2/M device consists of PFU blocks, which are provided in two forms, the PFU and PFF. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of this data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 50 inputs and 23 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

Slice 0 through Slice 2 contain two LUT4s feeding two registers, whereas Slice 3 contains two LUT4s only. For PFUs, Slice 0 and Slice 2 can also be configured as distributed memory, a capability not available in the PFF. Table 2-1 shows the capability of the slices in both PFF and PFU blocks along with the operation modes they enable. In addition, each PFU contains some logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge triggered or level sensitive clocks.

Table 2-1. Resources and Modes Available per Slice

Slice	PFU BLock		PFF Block	
	Resources	Modes	Resources	Modes
Slice 0	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 1	2 LUT4s and 2 Registers	Logic, Ripple, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 2	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 3	2 LUT4s	Logic, ROM	2 LUT4s	Logic, ROM

Slices 0, 1 and 2 have 14 input signals: 13 signals from routing and one from the carry-chain (from the adjacent slice or PFU). There are seven outputs: six to routing and one to carry-chain (to the adjacent PFU). Slice 3 has 13 input signals from routing and four signals to routing. Table 2-2 lists the signals associated with Slice 0 to Slice 2.

sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with 18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

EBR memory supports two forms of write behavior for single port or dual port operation:

1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADDSUB (Multiply, Addition/Subtraction)
- MULTADDSUBSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available on each block depends in the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-7 shows the capabilities of the block.

Table 2-7. Maximum Number of Elements in a Block

Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADDSUB	4	2	—
MULTADDSUBSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as a shift register from previous operand registers. By selecting “dynamic operation” the following operations are possible:

- In the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle.
- In the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.
- The loading of operands can switch between parallel and serial operations.

LatticeECP2/M DSP Performance

Table 2-11 lists the maximum performance in millions of MAC operations per second (MMAC) for each member of the LatticeECP2/M family.

Table 2-11. DSP Performance

Device	DSP Block	DSP Performance GMAC
ECP2-6	3	3.9
ECP2-12	6	7.8
ECP2-20	7	9.1
ECP2-35	8	10.4
ECP2-50	18	23.4
ECP2-70	22	28.6
ECP2M20	6	7.8
ECP2M35	8	10.4
ECP2M50	22	28.6
ECP2M70	24	31.2
ECP2M100	42	54.6

For further information about the sysDSP block, please see the list of additional technical information at the end of this data sheet.

Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O buffers as shown in Figure 2-28. The PIO Block supplies the output data (DO) and the tri-state control signal (TO) to the sysI/O buffer and receives input from the buffer. Table 2-12 provides the PIO signal list.

Table 2-14. Supported Output Standards

Output Standard	Drive	V _{CCIO} (Nom.)
Single-ended Interfaces		
LVTTL	4mA, 8mA, 12mA, 16mA, 20mA	3.3
LVC MOS33	4mA, 8mA, 12mA 16mA, 20mA	3.3
LVC MOS25	4mA, 8mA, 12mA, 16mA, 20mA	2.5
LVC MOS18	4mA, 8mA, 12mA, 16mA	1.8
LVC MOS15	4mA, 8mA	1.5
LVC MOS12	2mA, 6mA	1.2
LVC MOS33, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS25, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS18, Open Drain	4mA, 8mA, 12mA 16mA	—
LVC MOS15, Open Drain	4mA, 8mA	—
LVC MOS12, Open Drain	2mA, 6mA	—
PCI33	N/A	3.3
HSTL18 Class I, II	N/A	1.8
HSTL15 Class I	N/A	1.5
SSTL3 Class I, II	N/A	3.3
SSTL2 Class I, II	N/A	2.5
SSTL18 Class I, II	N/A	1.8
Differential Interfaces		
Differential SSTL3, Class I, II	N/A	3.3
Differential SSTL2, Class I, II	N/A	2.5
Differential SSTL18, Class I, II	N/A	1.8
Differential HSTL18, Class I, II	N/A	1.8
Differential HSTL15, Class I	N/A	1.5
LVDS	N/A	2.5
MLVDS ¹	N/A	2.5
BLVDS ¹	N/A	2.5
LVPECL ¹	N/A	3.3
RSDS ¹	N/A	2.5
LVC MOS33D ¹	4mA, 8mA, 12mA, 16mA, 20mA	3.3

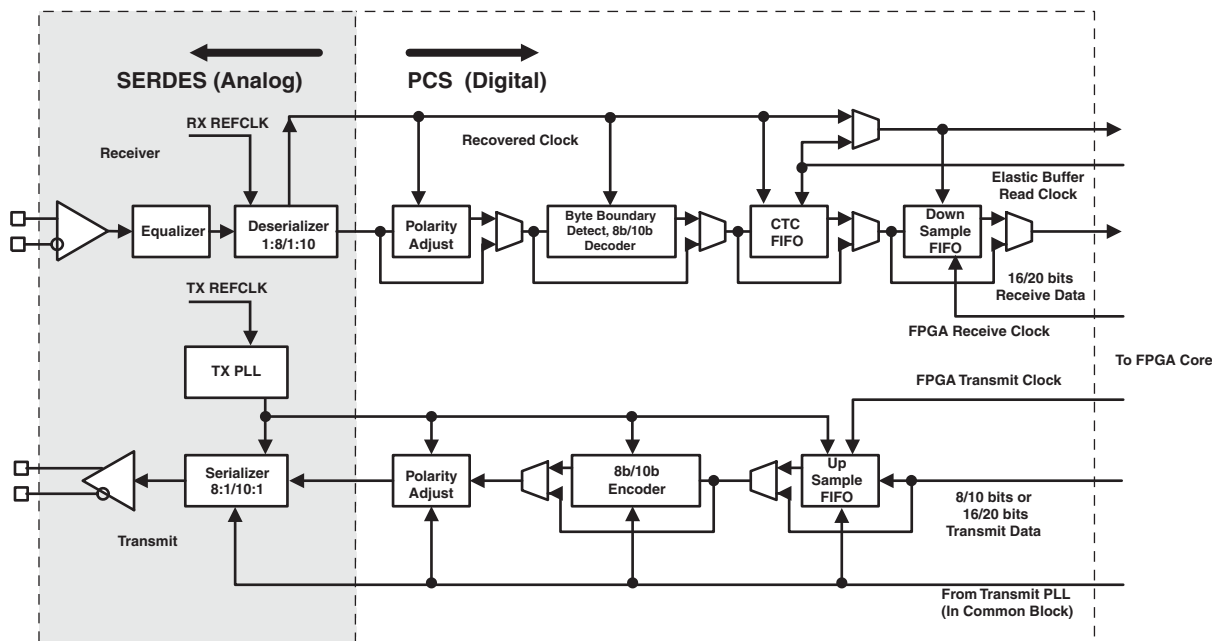
1. Emulated with external resistors. For more detail, please see information regarding additional technical documentation at the end of this data sheet.

Hot Socketing

LatticeECP2/M devices have been carefully designed to ensure predictable behavior during power-up and power-down. During power-up and power-down sequences, the I/Os remain in tri-state until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits. This allows for easy integration with the rest of the system. These capabilities make the LatticeECP2/M ideal for many multiple power supply and hot-swap applications.

Each Transmit and Receive channel has its independent power supplies. The Output and Input buffers of each channel also have their own independent power supplies. In addition, there are separate power supplies for PLL, terminating resistor per quad.

Figure 2-40. Simplified Channel Block Diagram for SERDES and PCS



PCS

As shown in Figure 2-40, the PCS receives the parallel digital data from the deserializer receivers and adjusts the polarity, detects, byte boundary, decodes (8b/10b) and provides Clock Tolerance Compensation (CTC) FIFO for changing the clock domain from receiver clock to the FPGA Clock.

For the transmit channel, the PCS block receives the parallel data from the FPGA core, encodes it with 8b/10b, adjusts the polarity and passes the 8/10 bit data to the transmit SERDES channel.

The PCS also provides bypass modes that allow a direct 8-bit or 10-bit interface from the SERDES to the FPGA logic. The PCS interface to FPGA can also be programmed to run at 1/2 speed for a 16-bit or 20-bit interface to the FPGA logic.

SCI (SERDES Client Interface) Bus

The SERDES Client Interface (SCI) is a soft IP interface that allow the SERDES/PCS Quad block to be controlled by registers as opposed to the configuration memory cells. It is a simple register configuration interface.

The Diamond design tools support all modes of the PCS. Most modes are dedicated to applications associated with a specific industry standard data protocol. Other more general purpose modes allow users to define their own operation. With Diamond, the user can define the mode for each quad in a design.

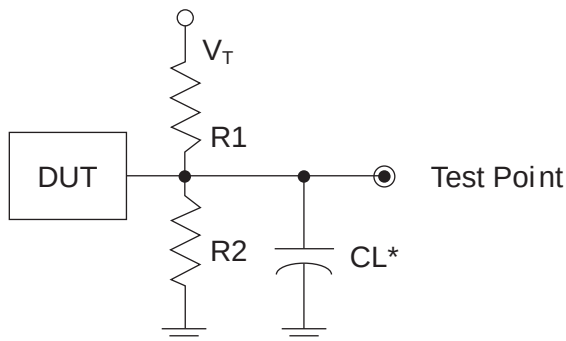
Popular standards such as 10Gb Ethernet and x4 PCI-Express and 4x Serial RapidIO can be implemented using IP (provided by Lattice), a single quad (Four SERDES channels and PCS) and some additional logic from the core.

For further information about SERDES, please see the list of additional technical documentation at the end of this data sheet.

Switching Test Conditions

Figure 3-22 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-19.

Figure 3-22. Output Test Load, LVTTTL and LVCMOS Standards



*CL Includes Test Fixture and Probe Capacitance

Table 3-19. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	R ₁	R ₂	C _L	Timing Ref.	V _T
LVTTTL and other LVCMOS settings (L → H, H → L)	∞	∞	0pF	LVCMOS 3.3 = 1.5V	—
				LVCMOS 2.5 = V _{CCIO} /2	—
				LVCMOS 1.8 = V _{CCIO} /2	—
				LVCMOS 1.5 = V _{CCIO} /2	—
				LVCMOS 1.2 = V _{CCIO} /2	—
LVCMOS 2.5 I/O (Z → H)	∞	1MΩ		V _{CCIO} /2	—
LVCMOS 2.5 I/O (Z → L)	1MΩ	∞		V _{CCIO} /2	V _{CCIO}
LVCMOS 2.5 I/O (H → Z)	∞	100		V _{OH} - 0.10	—
LVCMOS 2.5 I/O (L → Z)	100	∞		V _{OL} + 0.10	V _{CCIO}

Note: Output test conditions for all other interfaces are determined by the respective standards.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]_SQ_VCCI _{Bm}	—	Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_VCCO _{Bm}	—	Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_HDOU _{TNm}	O	High-speed output, negative channel m
[LOC]_SQ_HDOU _{TPm}	O	High-speed output, positive channel m
[LOC]_SQ_HDIN _{Nm}	I	High-speed input, negative channel m
[LOC]_SQ_HDIN _{Pm}	I	High-speed input, positive channel m
[LOC]_SQ_VCCT _{Xm} ⁴	—	Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.
[LOC]_SQ_VCCR _{Xm} ⁴	—	Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#).
5. There may be SPLs that do not have dedicated I/Os.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
3	PL4A	7		T (LVDS)*	PL6A	7	LDQ8	T (LVDS)*	
4	PL4B	7		C (LVDS)*	PL6B	7	LDQ8	C (LVDS)*	
5	GND	-			GND	-			
6	PL6A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ16	T (LVDS)*	
7	VCCAUX	-			VCCAUX	-			
8	PL6B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ16	C (LVDS)*	
9	PL8A	7	LDQ10	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*	
10	VCCIO7	7			VCCIO7	7			
11	PL8B	7	LDQ10	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*	
12	VCC	-			VCC	-			
13	GND	-			GND	-			
14	VCCIO7	7			VCCIO7	7			
15	PL12A	7	LDQ10	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*	
16	PL12B	7	LDQ10	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*	
17	GND	-			GND	-			
18	PL13A	7	PCLKT7_0/LDQ10	T	PL19A	7	PCLKT7_0/LDQ16	T	
19	VCC	-			VCC	-			
20	PL13B	7	PCLKC7_0/LDQ10	C	PL19B	7	PCLKC7_0/LDQ16	C	
21	PL15A	6	PCLKT6_0	T (LVDS)*	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	
22	PL15B	6	PCLKC6_0	C (LVDS)*	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	
23	PL16A	6	VREF2_6	T	PL22A	6	VREF2_6/LDQ25	T	
24	PL16B	6	VREF1_6	C	PL22B	6	VREF1_6/LDQ25	C	
25	GND	-			GND	-			
26	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	
27	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	
28	VCC	-			VCC	-			
29	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
30	VCCAUX	-			VCCAUX	-			
31	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	
32	GND	-			GND	-			
33	PL21A	6	LLM0_GPLLT_FB_A	T	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	
34	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	
35	PL21B	6	LLM0_GPLLC_FB_A	C	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	
36	PL23A	6			PL33A	6	LDQ34		
37	PL24A	6	LDQ28	T (LVDS)*	PL38A	6	LDQ42	T (LVDS)*	
38	VCCIO6	6			VCCIO6	6			
39	PL24B	6	LDQ28	C (LVDS)*	PL38B	6	LDQ42	C (LVDS)*	
40	VCC	-			VCC	-			
41	PL26A	6	LDQ28	T (LVDS)*	PL40A	6	LDQ42	T (LVDS)*	
42	GND	-			GND	-			
43	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
44	VCCIO6	6			VCCIO6	6			
45	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
92	PB44A	4	BDQ42	T	PB54A	4	BDQ51	T	
93	VCCIO4	4			VCCIO4	4			
94	PB44B	4	BDQ42	C	PB54B	4	BDQ51	C	
95	PB48A	4	BDQ51	T	PB58A	4	BDQ60	T	
96	PB48B	4	BDQ51	C	PB58B	4	BDQ60	C	
97	VCC	-			VCC	-			
98	PB52A	4	BDQ51	T	PB60A	4	BDQS60	T	
99	PB52B	4	BDQ51	C	PB60B	4	BDQ60	C	
100	VCCIO4	4			VCCIO4	4			
101	PB54A	4	BDQ51		PB63A	4	BDQ60		
102	GND	-			GND	-			
103	PB55A	4	VREF2_4/BDQ51	T	PB64A	4	VREF2_4/BDQ60	T	
104	PB55B	4	VREF1_4/BDQ51	C	PB64B	4	VREF1_4/BDQ60	C	
105	CFG1	8			CFG1	8			
106	PROGRAMN	8			PROGRAMN	8			
107	CFG2	8			CFG2	8			
108	INITN	8			INITN	8			
109	CFG0	8			CFG0	8			
110	CCLK	8			CCLK	8			
111	DONE	8			DONE	8			
112	PR29A	8	D0/SPIFASTN		PR43A	8	D0/SPIFASTN		
113	VCCIO8	8			VCCIO8	8			
114	PR26A	8	D6		PR40A	8	D6		
115	GND	-			GND	-			
116	VCC	-			VCC	-			
117	PR25B	8	D7/SPID0	C	PR39B	8	D7/SPID0	C	
118	VCCIO8	8			VCCIO8	8			
119	PR25A	8	DI/CSSPI0N	T	PR39A	8	DI/CSSPI0N	T	
120	PR24B	8	DOU/CSON	C	PR38B	8	DOU/CSON	C	
121	PR24A	8	BUSY/SISPI	T	PR38A	8	BUSY/SISPI	T	
122	GND	-			GND	-			
123	VCCIO3	3			VCCIO3	3			
124	PR21A	3	RLM0_GPLLT_FB_A		PR31A	3	RLM0_GPLLT_FB_A/RDQ34		
125	VCCAUX	-			VCCAUX	-			
126	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*	PR30B	3	RLM0_GPLLC_IN_A**/RDQ34	C (LVDS)*	
127	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR30A	3	RLM0_GPLLT_IN_A**/RDQ34	T (LVDS)*	
128	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
129	VCC	-			VCC	-			
130	PR18B	3	RLM0_GDLLC_FB_A	C	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	
131	PR18A	3	RLM0_GDLLT_FB_A	T	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	
132	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	
133	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	
134	PR16B	3	VREF2_3	C	PR22B	3	VREF2_3/RDQ25	C	
135	VCCIO3	3			VCCIO3	3			
136	PR16A	3	VREF1_3	T	PR22A	3	VREF1_3/RDQ25	T	
137	PR15B	3	PCLKC3_0	C (LVDS)*	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
184	GND	-			GND	-			
185	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
186	PT26B	0		C	PT36B	0		C	
187	PT26A	0		T	PT36A	0		T	
188	VCC	-			VCC	-			
189	PT20B	0		C	PT30B	0		C	
190	VCCAUX	-			VCCAUX	-			
191	PT20A	0		T	PT30A	0		T	
192	GND	-			GND	-			
193	PT18B	0		C	PT26B	0		C	
194	PT18A	0		T	PT26A	0		T	
195	VCCIO0	0			VCCIO0	0			
196	PT16B	0		C	PT20B	0		C	
197	PT16A	0		T	PT20A	0		T	
198	VCC	-			VCC	-			
199	PT12B	0		C	PT12B	0		C	
200	PT12A	0		T	PT12A	0		T	
201	GND	-			GND	-			
202	PT8B	0		C	PT8B	0		C	
203	PT8A	0		T	PT8A	0		T	
204	PT6B	0		C	PT6B	0		C	
205	PT6A	0		T	PT6A	0		T	
206	VCCIO0	0			VCCIO0	0			
207	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
208	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA
(Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M19	NC	-			PR26A	3	RDQ25	T
J22	NC	-			PR23B	3	RDQ25	C (LVDS)*
-	-	-			GNDIO	-		
L22	NC	-			PR24B	3	RDQ25	C
H22	NC	-			PR23A	3	RDQ25	T (LVDS)*
K22	NC	-			PR24A	3	RDQ25	T
M20	PR16B	3	VREF2_3	C	PR22B	3	VREF2_3/RDQ25	C
VCCIO	VCCIO3	3			VCCIO3	3		
L21	PR16A	3	VREF1_3	T	PR22A	3	VREF1_3/RDQ25	T
K21	PR15B	3	PCLKC3_0	C (LVDS)*	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*
J21	PR15A	3	PCLKT3_0	T (LVDS)*	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*
M18	PR13B	2	PCLKC2_0/RDQ10	C	PR19B	2	PCLKC2_0/RDQ16	C
GNDIO	GNDIO2	-			GNDIO2	-		
L17	PR13A	2	PCLKT2_0/RDQ10	T	PR19A	2	PCLKT2_0/RDQ16	T
L19	PR12B	2	RDQ10	C (LVDS)*	PR18B	2	RDQ16	C (LVDS)*
K18	PR10B	2	RDQ10	C (LVDS)*	PR16B	2	RDQ16	C (LVDS)*
L20	PR12A	2	RDQ10	T (LVDS)*	PR18A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
K19	PR10A	2	RDQS10	T (LVDS)*	PR16A	2	RDQS16	T (LVDS)*
L18	PR11B	2	RDQ10	C	PR17B	2	RDQ16	C
K17	PR11A	2	RDQ10	T	PR17A	2	RDQ16	T
GNDIO	GNDIO2	-			GNDIO2	-		
J17	PR8B	2	RDQ10	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
G22	PR9B	2	RDQ10	C	PR15B	2	RDQ16	C
J18	PR8A	2	RDQ10	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
F22	PR9A	2	RDQ10	T	PR15A	2	RDQ16	T
VCCIO	VCCIO2	2			VCCIO2	2		
H21	PR6B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
K20	PR7B	2	RDQ10	C	PR13B	2	RDQ16	C
G21	PR6A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
J19	PR7A	2	RDQ10	T	PR13A	2	RDQ16	T
D22	NC	-			PR10B	2	RDQ8	C (LVDS)*
F21	NC	-			PR11B	2	RDQ8	C
-	-	-			GNDIO	-		
E21	NC	-			PR10A	2	RDQ8	T (LVDS)*
E22	NC	-			PR11A	2	RDQ8	T
H19	NC	-			PR8B	2	RDQ8	C (LVDS)*
G20	NC	-			PR9B	2	RDQ8	C
-	-	-			VCCIO2	2		
G19	NC	-			PR8A	2	RDQS8	T (LVDS)*
F20	NC	-			PR9A	2	RDQ8	T
G17	PR5B	2		C	PR7B	2	RDQ8	C
GNDIO	GNDIO2	-			GNDIO2	-		
E20	PR4B	2		C (LVDS)*	PR6B	2	RDQ8	C (LVDS)*

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D2	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7/LDQ6	T (LVDS)*	
D1	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7/LDQ6	C (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
F6	PL3A	7		T	PL3A	7	LDQ6	T	
F5	PL3B	7		C	PL3B	7	LDQ6	C	
VCCIO	VCCIO7	7			VCCIO7	7			
E4	NC	-			PL4A	7	LDQ6	T (LVDS)*	
E3	NC	-			PL4B	7	LDQ6	C (LVDS)*	
E2	NC	-			PL5A	7	LDQ6	T	
E1	NC	-			PL5B	7	LDQ6	C	
GND	GNDIO7	-			GNDIO7	-			
H6	NC	-			PL6A	7	LDQS6	T (LVDS)*	
H5	NC	-			PL6B	7	LDQ6	C (LVDS)*	
F2	NC	-			PL7A	7	LDQ6	T	
VCCIO	VCCIO7	7			VCCIO7	7			
F1	NC	-			PL7B	7	LDQ6	C	
H8	NC	-			PL8A	7	LDQ6	T (LVDS)*	
J9	NC	-			PL8B	7	LDQ6	C (LVDS)*	
G4	NC	-			PL9A	7	LDQ6	T	
GND	GNDIO7	-			GNDIO7	-			
G3	NC	-			PL9B	7	LDQ6	C	
H7	PL4A	7	LDQ8	T (LVDS)*	PL10A	7	LDQ14	T (LVDS)*	
J8	PL4B	7	LDQ8	C (LVDS)*	PL10B	7	LDQ14	C (LVDS)*	
G2	PL5A	7	LDQ8	T	PL11A	7	LDQ14	T	
G1	PL5B	7	LDQ8	C	PL11B	7	LDQ14	C	
H3	PL6A	7	LDQ8	T (LVDS)*	PL12A	7	LDQ14	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
H4	PL6B	7	LDQ8	C (LVDS)*	PL12B	7	LDQ14	C (LVDS)*	
J5	PL7A	7	LDQ8	T	PL13A	7	LDQ14	T	
J4	PL7B	7	LDQ8	C	PL13B	7	LDQ14	C	
J3	PL8A	7	LDQS8	T (LVDS)*	PL14A	7	LDQS14	T (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
K4	PL8B	7	LDQ8	C (LVDS)*	PL14B	7	LDQ14	C (LVDS)*	
H1	PL9A	7	LDQ8	T	PL15A	7	LDQ14	T	
H2	PL9B	7	LDQ8	C	PL15B	7	LDQ14	C	
VCCIO	VCCIO7	7			VCCIO7	7			
K6	PL10A	7	LDQ8	T (LVDS)*	PL16A	7	LDQ14	T (LVDS)*	
K7	PL10B	7	LDQ8	C (LVDS)*	PL16B	7	LDQ14	C (LVDS)*	
J1	PL11A	7	LDQ8	T	PL17A	7	LDQ14	T	
J2	PL11B	7	LDQ8	C	PL17B	7	LDQ14	C	
GND	GNDIO7	-			GNDIO7	-			
VCCIO	VCCIO7	7			VCCIO7	7			
K3	NC	-			NC	-			
K2	NC	-			NC	-			
GND	GNDIO7	-			GNDIO7	-			
K1	NC	-			NC	-			

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AE17	PB51B	4	BDQ51	C	PB51B	4	BDQ51	C	
AB19	PB52A	4	BDQ51	T	PB52A	4	BDQ51	T	
AE19	PB52B	4	BDQ51	C	PB52B	4	BDQ51	C	
AF17	PB53A	4	BDQ51	T	PB53A	4	BDQ51	T	
AE18	PB53B	4	BDQ51	C	PB53B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
W16	PB54A	4	BDQ51	T	PB54A	4	BDQ51	T	
AA17	PB54B	4	BDQ51	C	PB54B	4	BDQ51	C	
AF18	PB55A	4	BDQ51	T	PB55A	4	BDQ51	T	
AF19	PB55B	4	BDQ51	C	PB55B	4	BDQ51	C	
GND	GNDIO4	-			GNDIO4	-			
AA19	NC	-			PB56A	4	BDQ60	T	
W17	NC	-			PB56B	4	BDQ60	C	
Y19	NC	-			PB57A	4	BDQ60	T	
Y17	NC	-			PB57B	4	BDQ60	C	
AF20	NC	-			NC	-			
VCCIO	VCCIO4	4			VCCIO4	4			
AE20	NC	-			NC	-			
AA20	NC	-			NC	-			
W18	NC	-			NC	-			
AD20	NC	-			NC	-			
GND	GNDIO4	-			GNDIO4	-			
AE21	NC	-			NC	-			
AF21	NC	-			NC	-			
AF22	NC	-			NC	-			
VCCIO	VCCIO4	4			VCCIO4	4			
GND	GNDIO4	-			GNDIO4	-			
AE22	PB56A	4	BDQ60	T	PB65A	4	BDQ69	T	
AD22	PB56B	4	BDQ60	C	PB65B	4	BDQ69	C	
AF23	PB57A	4	BDQ60	T	PB66A	4	BDQ69	T	
AE23	PB57B	4	BDQ60	C	PB66B	4	BDQ69	C	
AD23	PB58A	4	BDQ60	T	PB67A	4	BDQ69	T	
AC23	PB58B	4	BDQ60	C	PB67B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AB20	PB59A	4	BDQ60	T	PB68A	4	BDQ69	T	
AC20	PB59B	4	BDQ60	C	PB68B	4	BDQ69	C	
GND	GNDIO4	-			GNDIO4	-			
AB21	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T	
AC22	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C	
W19	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T	
AA21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C	
AF24	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T	
AE24	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
Y20	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T	
AB22	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR43B	2	RDQ41	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
K22	PR43A	2	RDQ41	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
M24	PR42B	2	RDQ41	C	PR55B	2	RDQ54	C
N23	PR42A	2	RDQ41	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR41B	2	RDQ41	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
K25	PR41A	2	RDQS41	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
M20	PR40B	2	RDQ41	C	PR53B	2	RDQ54	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR40A	2	RDQ41	T	PR53A	2	RDQ54	T
L22	PR39B	2	RDQ41	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
M22	PR39A	2	RDQ41	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
K21	PR38B	2	RDQ41	C	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR38A	2	RDQ41	T	PR51A	2	RDQ54	T
K24	PR37B	2	RDQ41	C (LVDS)*	PR50B	2	RDQ54	C (LVDS)*
J24	PR37A	2	RDQ41	T (LVDS)*	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCCPLL	2			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
J25	PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
J23	PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
K23	PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
H26	PR24B	2	RDQ24	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*
H25	PR24A	2	RDQS24***	T (LVDS)*	PR37A	2	RDQS37***	T (LVDS)*
H24	PR23B	2	RDQ24	C	PR36B	2	RDQ37	C
GND	GNDIO2	-			GNDIO2	-		
H23	PR23A	2	RDQ24	T	PR36A	2	RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR19B	2	RDQ16	C	PR32B	2	RDQ29	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR19A	2	RDQ16	T	PR32A	2	RDQ29	T
F26	PR18B	2	RDQ16	C (LVDS)*	PR31B	2	RDQ29	C (LVDS)*
F25	PR18A	2	RDQ16	T (LVDS)*	PR31A	2	RDQ29	T (LVDS)*
K20	PR17B	2	RDQ16	C	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR17A	2	RDQ16	T	PR30A	2	RDQ29	T
E26	PR16B	2	RDQ16	C (LVDS)*	PR29B	2	RDQ29	C (LVDS)*
E25	PR16A	2	RDQS16	T (LVDS)*	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR15B	2	RDQ16	C	PR28B	2	RDQ29	C
H22	PR15A	2	RDQ16	T	PR28A	2	RDQ29	T

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
T7	PB22A	4	PCLKT4_0/BDQ24	T	PB40A	4	PCLKT4_0/BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
T8	PB22B	4	PCLKC4_0/BDQ24	C	PB40B	4	PCLKC4_0/BDQ42	C
L7	PB23A	4	VREF2_4/BDQ24	T	PB41A	4	VREF2_4/BDQ42	T
L8	PB23B	4	VREF1_4/BDQ24	C	PB41B	4	VREF1_4/BDQ42	C
GNDIO	GNDIO4	-			GNDIO4	-		
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
P8	PB29A	4	BDQ33	T	PB47A	4	BDQ51	T
N8	PB29B	4	BDQ33	C	PB47B	4	BDQ51	C
R7	PB30A	4	BDQ33	T	PB48A	4	BDQ51	T
R8	PB30B	4	BDQ33	C	PB48B	4	BDQ51	C
N7	PB31A	4	BDQ33	T	PB49A	4	BDQ51	T
M8	PB31B	4	BDQ33	C	PB49B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
R9	PB32A	4	BDQ33	T	PB50A	4	BDQ51	T
T9	PB32B	4	BDQ33	C	PB50B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO4	-		
T10	PB33A	4	BDQS33	T	PB51A	4	BDQS51	T
R10	PB33B	4	BDQ33	C	PB51B	4	BDQ51	C
N9	PB34A	4	BDQ33	T	PB52A	4	BDQ51	T
P10	PB34B	4	BDQ33	C	PB52B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
L9	PB47A	4	BDQ51	T	PB65A	4	BDQ69	T
M9	PB47B	4	BDQ51	C	PB65B	4	BDQ69	C
T11	PB49A	4	BDQ51	T	PB67A	4	BDQ69	T
R11	PB49B	4	BDQ51	C	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
T12	PB50A	4	BDQ51	T	PB68A	4	BDQ69	T
T13	PB50B	4	BDQ51	C	PB68B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
P11	PB51A	4	BDQS51	T	PB69A	4	BDQS69	T
N10	PB51B	4	BDQ51	C	PB69B	4	BDQ69	C
T14	PB52A	4	BDQ51	T	PB70A	4	BDQ69	T
R13	PB52B	4	BDQ51	C	PB70B	4	BDQ69	C
R15	PB53A	4	BDQ51	T	PB71A	4	BDQ69	T
R16	PB53B	4	BDQ51	C	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
R14	PB54A	4	BDQ51	T	PB72A	4	BDQ69	T
P15	PB54B	4	BDQ51	C	PB72B	4	BDQ69	C
P16	PB55A	4	BDQ51	T	PB73A	4	BDQ69	T
P14	PB55B	4	BDQ51	C	PB73B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
L11	CFG2	8			CFG2	8		
L10	CFG1	8			CFG1	8		
P13	CFG0	8			CFG0	8		
N12	PROGRAMN	8			PROGRAMN	8		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A7	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
C6	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
B4	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B3	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
A4	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
C3	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO1	1		
GNDIO	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
G10	VCCPLL	-			VCCPLL	-		
G7	VCC	-			VCC	-		
G9	VCC	-			VCC	-		
H7	VCC	-			VCC	-		
J10	VCC	-			VCC	-		
K10	VCC	-			VCC	-		
K8	VCC	-			VCC	-		
E7	VCCIO0	0			VCCIO0	0		
VCCIO	VCCIO0	0			VCCIO0	0		
E10	VCCIO1	1			VCCIO1	1		
VCCIO	VCCIO1	1			VCCIO1	1		
E14	VCCIO2	2			VCCIO2	2		
G12	VCCIO2	2			VCCIO2	2		
VCCIO	VCCIO2	2			VCCIO2	2		
K12	VCCIO3	3			VCCIO3	3		
M14	VCCIO3	3			VCCIO3	3		
VCCIO	VCCIO3	3			VCCIO3	3		
M10	VCCIO4	4			VCCIO4	4		
P12	VCCIO4	4			VCCIO4	4		
VCCIO	VCCIO4	4			VCCIO4	4		
M7	VCCIO5	5			VCCIO5	5		
P5	VCCIO5	5			VCCIO5	5		
VCCIO	VCCIO5	5			VCCIO5	5		
K5	VCCIO6	6			VCCIO6	6		
M3	VCCIO6	6			VCCIO6	6		
VCCIO	VCCIO6	6			VCCIO6	6		
E3	VCCIO7	7			VCCIO7	7		
G5	VCCIO7	7			VCCIO7	7		
VCCIO	VCCIO7	7			VCCIO7	7		
T15	VCCIO8	8			VCCIO8	8		
VCCIO	VCCIO8	8			VCCIO8	8		
G8	VCCAUX	-			VCCAUX	-		
H10	VCCAUX	-			VCCAUX	-		
J7	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A15	GND	-			GND	-		
A16	GND	-			GND	-		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P8	PL45A	6	LDQ48	T	PL49A	6	LDQ52	T	
R6	PL45B	6	LDQ48	C	PL49B	6	LDQ52	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T1	PL46A	6	LDQ48	T (LVDS)*	PL50A	6	LDQ52	T*	
U1	PL46B	6	LDQ48	C (LVDS)*	PL50B	6	LDQ52	C*	
R7	PL47A	6	LDQ48	T	PL51A	6	LDQ52	T	
T5	PL47B	6	LDQ48	C	PL51B	6	LDQ52	C	
GNDIO	GNDIO6	-			GNDIO6	-			
U3	PL48A	6	LDQS48	T (LVDS)*	PL52A	6	LDQS52	T*	
U4	PL48B	6	LDQ48	C (LVDS)*	PL52B	6	LDQ52	C*	
U5	PL49A	6	LDQ48	T	PL53A	6	LDQ52	T	
VCCIO	VCCIO6	6			VCCIO6	6			
U6	PL49B	6	LDQ48	C	PL53B	6	LDQ52	C	
U2	PL50A	6	LDQ48	T (LVDS)*	PL54A	6	LDQ52	T*	
V1	PL50B	6	LDQ48	C (LVDS)*	PL54B	6	LDQ52	C*	
W2	PL51A	6	LDQ48	T	PL55A	6	LDQ52	T	
GNDIO	GNDIO6	-			GNDIO6	-			
V2	PL51B	6	LDQ48	C	PL55B	6	LDQ52	C	
V4	PL55A	6	LDQ57	T (LVDS)*	PL59A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
V3	PL55B	6	LDQ57	C (LVDS)*	PL59B	6		C*	
-	-	-			GNDIO6	-			
W4	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57****	T (LVDS)*	PL62A	6	LLM0_GPLLT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
W3	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*	PL62B	6	LLM0_GPLLC_IN_A	C*	
W1	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T	PL63A	6	LLM0_GPLLT_FB_A	T	
Y1	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C	PL63B	6	LLM0_GPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
AA1	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*	PL64A	6	LLM0_GDLLT_IN_A	T*	
AB1	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	PL64B	6	LLM0_GDLLC_IN_A	C*	
U7	PL60A	6	LLM0_GDLLT_FB_A/LDQ57	T	PL65A	6	LLM0_GDLLT_FB_A	T	
V6	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C	PL65B	6	LLM0_GDLLC_FB_A	C	
GNDIO	GNDIO6	-			GNDIO6	-			
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
W5	PL62A	6	LDQ66	T (LVDS)*	PL67A	6	LDQ71	T*	
Y4	PL62B	6	LDQ66	C (LVDS)*	PL67B	6	LDQ71	C*	
U8	PL63A	6	LDQ66	T	PL68A	6	LDQ71	T	
W6	PL63B	6	LDQ66	C	PL68B	6	LDQ71	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y3	PL64A	6	LDQ66	T (LVDS)*	PL69A	6	LDQ71	T*	
AA3	PL64B	6	LDQ66	C (LVDS)*	PL69B	6	LDQ71	C*	
V7	NC	-			PL70A	6	LDQ71	T	
Y5	PL65B	6	LDQ66	C	PL70B	6	LDQ71	C	
GNDIO	GNDIO6	-			GNDIO6	-			
AB2	PL66A	6	LDQS66	T (LVDS)*	PL71A	6	LDQS71	T*	
AA4	PL66B	6	LDQ66	C (LVDS)*	PL71B	6	LDQ71	C*	
Y6	PL67A	6	LDQ66	T	PL72A	6	LDQ71	T	
VCCIO	VCCIO6	6			VCCIO6	6			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF23	PB64A	4	BDQ60	T	LRC_SQ_HDINP1	13		T	
AD23	NC	-			LRC_SQ_VCCIB1	13			
AE23	PB66B	4	BDQ69	C	LRC_SQ_HDINN1	13		C	
AD24	VCC	-			LRC_SQ_VCCRX1	13			
AF20	PB55A	4	BDQ51	T	LRC_SQ_HDOUTP1	13		T	
AD20	NC	-			LRC_SQ_VCCOB1	13			
AE20	PB55B	4	BDQ51	C	LRC_SQ_HDOUTN1	13		C	
AD21	VCC	-			LRC_SQ_VCCTX1	13			
AE21	PB63B	4	BDQ60	C	LRC_SQ_HDOUTN0	13		C	
AF22	NC	-			LRC_SQ_VCCOB0	13			
AF21	PB62A	4	BDQ60	T	LRC_SQ_HDOUTP0	13		T	
AD22	VCC	-			LRC_SQ_VCCTX0	13			
AE24	PB67B	4	BDQ69	C	LRC_SQ_HDINN0	13		C	
AE25	NC	-			LRC_SQ_VCCIB0	13			
AF24	PB67A	4	BDQ69	T	LRC_SQ_HDINP0	13		T	
AD25	VCC	-			LRC_SQ_VCCRX0	13			
AA21	CFG2	8			CFG2	8			
AA22	CFG1	8			CFG1	8			
AB23	CFG0	8			CFG0	8			
AC26	PROGRAMN	8			PROGRAMN	8			
AB24	CCLK	8			CCLK	8			
AA23	INITN	8			INITN	8			
AB25	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
Y19	PR68B	8	WRITEN***	C	WRITEN***	8			
Y21	PR68A	8	CS1N***	T	CS1N***	8			
AB26	PR67B	8	CSN***	C	CSN***	8			
Y22	PR67A	8	D0/SPIFASTN***	T	D0/SPIFASTN***	8			
VCCIO	VCCIO8	8				8			
W19	PR66B	8	D1***	C	D1***	8			
Y20	PR66A	8	D2***	T	D2***	8			
W22	PR65B	8	D3***	C	D3***	8			
GNDIO	GNDIO8	-				-			
W18	PR65A	8	D4***	T	D4***	8			
Y23	PR64B	8	D5***	C	D5***	8			
AA24	PR64A	8	D6***	T	D6***	8			
W21	PR63B	8	D7/SPID0***	C	D7/SPID0***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
V20	PR63A	8	DI/CSSPI0N***	T	DI/CSSPI0N***	8			
W23	PR62B	8	DOUT/CSON/CSSPI1N***	C	DOUT/CSON/ CSSPI1N***	8			
Y24	PR62A	8	BUSY/SISPI***	T	BUSY/SISPI***	8			
V19	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
V21	PR60B	3	RLM0_GDLLC_FB_A	C	PR65B	3	RLM0_GDLLC_FB_A	C	
GNDIO	GNDIO3	-			GNDIO3	-			
U19	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T	PR65A	3	RLM0_GDLLT_FB_A	T	
AA26	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C (LVDS)*	PR64B	3	RLM0_GDLLC_IN_A	C*	
Y26	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*	PR64A	3	RLM0_GDLLT_IN_A	T*	
V23	PR58B	3	RLM0_GPLLC_IN_A**/RDQ57	C	PR63B	3	RLM0_GPLLC_IN_A	C	

Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVC MOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
			Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
April 2008	03.1	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
June 2008	03.2	Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
			Clarification of the operation of the secondary clock regions.
		DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
August 2008	03.3	Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPI _m Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.